

25

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102028208		To the Honorable Commissioner of Patents and Trademarks			
1. Name of conveying party(ies): Takatomo TODA Naoki MAKINO Additional name of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		2. Name and address of receiving party(ies) Name: Seiko Epson Corporation Internal Address: Street Address: 4-1, Nishi-shinjuku 2-chome, Shinjuku-ku City: Tokyo State: JAPAN Zip: Additional Name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No			
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other _____ Execution Date(s): February 4, 2002					
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: _____ A. Patent Application No.(s) 09/999,207 B. Patent No.(s) Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No					
5. Name and address of party to whom correspondence concerning this document should be mailed: Name: G. Gregory Schivley / Bryant E. Wade Internal Address: Harness, Dickey & Pierce, P.L.C. Street Address: P.O. Box 828 City: Bloomfield Hills State: MI Zip: 48303		6. Total number of applications and/or patents involved: 1 7. Total fee (37 CFR 3.41) \$ 40 <input checked="" type="checkbox"/> Enclosed <input type="checkbox"/> Authorized to be charged to deposit account 8. The Commissioner is hereby authorized to charge any additional fees that may be required or credit any overpayments to Deposit Account No. 08-0750. A duplicate copy of this sheet is enclosed.			
DO NOT USE THIS SPACE					
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. G. Gregory Schivley/Bryant Wade Name of Person Signing February 27, 2002 Date Total number of pages including cover sheet, attachments, and documents: 3					

Mail documents to be recorded with required cover sheet information to:

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03/21/2002 LMUELLER 00000299 09999207

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PATENT
REEL: 012690 FRAME: 0775

譲渡証 (Translation/日本語訳)

下記に署名した私/私達、

戸田 貴友、牧野 直樹 は、

ある発明を創出し、これについて合衆国特許出願は

- ☐ ここに私/私達により署名され、
☐ _____に私/私達により（それぞれ）署名され、
☒ 2001 年 11 月 30 日に出願され、出願番号09/999,207が
 交付され、
☐ PCT 国際出願 _____として_____に出願され、

その発明は

半導体チップ実装基板、電気光学装置、液晶装置、エレクトロルミ
 ネッセンス装置及び電子機器

という名称である。そして、ここにその受領を認める対価で：
 私/私達は、当該発明/出願について、合衆国とその属領及び
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 権利、所有権、利益；一部継続出願、継続出願、分割出願、
 差替え出願、再発行出願、特許期間延長等、合衆国とその属領
 及び全ての外国に於いて既に出願されたか若しくは今後出願
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 約、法令、協定（将来制定されるものを含む）に基づく全ての
 優先権を伴う一切の権利；を、日本国東京都新宿区西新宿 2 丁
 目 4 番 1 号に住所を有するセイコーエプソン株式会社、その後
 継者、譲受人及び法定代理人に対して、売却、譲渡、移転する
 ものとする。

さらに、私/私達は、セイコーエプソン株式会社（以下譲受人
 と言う）が単数ないしは複数の当該発明（以下当該発明という）
 に関わる特許権を、自己の名により、合衆国とその属領及び全
 体の外国に於いて出願し、特許を受けること；またこの譲渡証
 の意図と目的を誠実に実行することを求められた場合、下記に
 署名した私/私達が、当該譲受人、その後継者、その被譲渡者、
 及び法定代理人の費用負担にて、一部継続出願、継続出願、分
 割出願、差替え出願、再発行出願、特許期間延長等を行い、合
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 または準法的訴訟手続に於いて証言を行うこと；当該発明とそ
 の経緯に関連して、下記に署名した私/私達が知り得た全ての
 事実を、当該譲受人、後継者、被譲渡者、及び法定代理人に連
 絡すること；そして当該譲受人、後継者、被譲渡者、及び法定
 代理人が、当該発明の特許権の適切な保護、維持、権利行使す
 るために望ましいと考慮すること、また、当該発明に関わる特
 許出願に際し、当該譲受人、後継者、被譲渡者、及び法定代理
 人に対して法的権限を付与することが望ましいと考慮すること
 について、可能な限り行うことを承諾する。

Assignment

For good and valuable consideration, the receipt of which is
 hereby acknowledged, I/WE, the undersigned,

Takatomo TODA, Naoki MAKINO,

who have created a certain invention for which an application for
 United States Letters Patent

- ☐ executed by ME/US on even date herewith,
☐ executed by ME/US on _____, (respectively),
☒ filed on November 30, 2001 and assigned Serial No.
 09/999,207,
☐ filed as International Application No. _____ filed on
 _____,

and entitled:

SEMICONDUCTOR CHIP MOUNTING SUBSTRATE,
 ELECTROOPTICAL DEVICE, LIQUID-CRYSTAL DEVICE,
 ELECTROLUMINESCENT DEVICE, AND ELECTRONIC
 EQUIPMENT

Do hereby sell, assign and transfer to Seiko Epson Corporation,
 a corporation of Japan, having a place of business at 4-1,
 Nishi-shinjuku 2-chome, Shinjuku-ku, Tokyo, Japan, its
 successors, assigns, and legal representatives, the full and
 exclusive right to said invention and said application and to any
 and all inventions described in said application for the United
 States, its territorial possessions and all foreign countries, and the
 entire right, title and interest in and to any and all Letters Patent
 which may be granted therefor in the United States, its territorial
 possessions and all foreign countries; and in and to any and all
 continuations-in-part, continuations, divisions, substitutes,
 reissues, extensions thereof, and all other applications for Letters
 Patent relating thereto which have been or shall be filed in the
 United States, its territorial possessions and/or any foreign
 countries, and all rights, together with all priority rights, under any
 of the international conventions, unions, agreements, acts, and
 treaties, including all future conventions, unions, agreements, acts,
 and treaties;

Agree that Seiko Epson Corporation, hereinafter referred to as
 Assignee, may apply for and receive Letters Patent for said
 invention and said inventions, hereinafter referred to as said
 invention, in its own name, in the United States, its territorial
 possessions, and all foreign countries; and that, when requested to
 carry out in good faith the intent and purpose of this assignment,
 at the expense of said Assignee, its successors, assigns and legal
 representatives, the undersigned will execute all
 continuations-in-part, continuations, divisions, substitutes,
 reissues, extensions thereof, execute all rightful oaths,
 assignments, powers of attorney and other papers, testify in any
 legal or quasi legal proceedings; communicate to said Assignee, its
 successors, assigns or legal representatives all facts known to the
 undersigned relating to said invention and the history thereof; and
 generally do everything possible which said Assignee, its
 successors, assigns, or legal representatives shall consider
 desirable for aiding in securing, maintaining and enforcing proper
 patent protection for said invention and for vesting title to said
 invention and all applications for patents on said invention in said
 Assignee, its successors, assigns, or legal representatives; and

そして、私／私達は、この書面により譲渡された権利や財産に影響する、如何なる譲渡、授權、抵当権、ライセンス等その他の協定も他の第三者との間で行っていないこと；下記に署名した私／私達によって、この書面に記載されている権利が所有されていることを、当該譲受人、後継者、被譲渡者、及び法定代理人に対して誓約するものである。

さらに、下記に署名した私／私達はこの譲渡書は英語の部分の表現によってのみ解釈されることに同意する。

上記を証明するため、私／私達は下記日付で署名する。

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

I/WE, the undersigned do further agree that this Assignment is to be construed solely according to the terms of the English language portions thereof.

IN TESTIMONY WHEREOF I/WE have hereunto set MY/OUR signature seal on the date indicated below.

唯一または第一発明者名 戸田 貴友		Full name of sole or first inventor Takatomo TODA	
発明者の署名 戸田 貴友	日付 '02.2.4	Inventor's signature Takatomo Toda	Date Feb. 4, 2002
第二共同発明者 (いる場合) 牧野 直樹		Full name of second joint inventor, if any Naoki MAKINO	
第二共同発明者の署名 牧野 直樹	日付 '02.2.9	Second Inventor's signature Naoki Makino	Date Feb. 7, 2002
第三共同発明者 (いる場合)		Full name of third joint inventor, if any	
第三共同発明者の署名	日付	Third Inventor's signature	Date
第四共同発明者 (いる場合)		Full name of fourth joint inventor, if any	
第四共同発明者の署名	日付	Fourth Inventor's signature	Date
第五共同発明者 (いる場合)		Full name of fifth joint inventor, if any	
第五共同発明者の署名	日付	Fifth Inventor's signature	Date
第六共同発明者 (いる場合)		Full name of sixth joint inventor, if any	
第六共同発明者の署名	日付	Sixth Inventor's signature	Date
第七共同発明者 (いる場合)		Full name of seventh joint inventor, if any	
第七共同発明者の署名	日付	Seventh Inventor's signature	Date
第八共同発明者 (いる場合)		Full name of eighth joint inventor, if any	
第八共同発明者の署名	日付	Eighth Inventor's signature	Date